

Product data sheet

1. Product profile

1.1 General description

The BFR505 is an NPN silicon planar epitaxial transistor, intended for applications in the RF front end in wideband applications in the GHz range, such as analog and digital cellular telephones, cordless telephones (CT1, CT2, DECT, etc.), radar detectors, pagers and satellite TV tuners (SATV).

The transistor is encapsulated in a plastic SOT23 envelope.

1.2 Features and benefits

- High power gain
- Low noise figure
- High transition frequency
- Gold metallization ensures excellent reliability.

1.3 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{CBO}	collector-base voltage	open emitter		-	-	20	V
V _{CES}	collector-emitter voltage	$R_{BE} = 0 \Omega$		-	-	15	V
I _C	DC collector current			-	-	18	mA
P _{tot}	total power dissipation	up to $T_s = 135$ °C	[1]	-	-	150	mW
h _{FE}	DC current gain	$I_C = 5 \text{ mA}; V_{CE} = 6 \text{ V}$		60	120	250	
C _{re}	feedback capacitance	$I_C = I_c = 0 \text{ A}; V_{CB} = 6 \text{ V}; f = 1 \text{ MHz}$		-	0.3	-	pF
f _T	transition frequency	$I_C = 5 \text{ mA}; V_{CE} = 6 \text{ V}; f = 1 \text{ GHz}$		-	9	-	GHz
G_UM	maximum unilateral power gain	$I_C = 5 \text{ mA}; V_{CE} = 6 \text{ V};$ $T_{amb} = 25 ^{\circ}\text{C}; f = 900 \text{ MHz}$		-	17	-	dB
		$I_C = 5$ mA; $V_{CE} = 6$ V; $T_{amb} = 25$ °C; $f = 2$ GHz		-	10	-	dB
S ₂₁ ²	insertion power gain	$I_C = 5 \text{ mA}; V_{CE} = 6 \text{ V};$ $T_{amb} = 25 ^{\circ}\text{C}; f = 900 \text{ MHz}$		13	14	-	dB



NPN 9 GHz wideband transistor

Table 1. Quick reference data ...continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
F	noise figure	$\Gamma_{\text{S}} = \Gamma_{\text{opt}}$; $I_{\text{C}} = 1.25$ mA; $V_{\text{CE}} = 6$ V; $T_{\text{amb}} = 25$ °C; $f = 900$ MHz	-	1.2	1.7	dB
		$\Gamma_{\text{S}} = \Gamma_{\text{opt}}$; $I_{\text{C}} = 5$ mA; $V_{\text{CE}} = 6$ V; $T_{\text{amb}} = 25$ °C; $f = 900$ MHz	-	1.6	2.1	dB
		$\Gamma_{\text{s}} = \Gamma_{\text{opt}}$; $I_{\text{C}} = 1.25$ mA; $V_{\text{CE}} = 6$ V; $T_{\text{amb}} = 25$ °C; $f = 2$ GHz	-	1.9	-	dB

^[1] T_s is the temperature at the soldering point of the collector tab.

2. Pinning information

Table 2. Discrete pinning

	p	
Pin	Description	Simplified outline Symbol
1	base	
2	emitter	<u> 3</u>
3	collector	1 - 2
		sym021

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BFR505	-	plastic surface mounted package; 3 leads	SOT23

4. Marking

Table 4. Marking table

Type number	Marking code ^[1]
BFR505	31*

^{[1] * =} p: made in Hong Kong.

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^{* =} t: made in Malaysia.

^{* =} W: made in China.

NPN 9 GHz wideband transistor

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CBO}	collector-base voltage	open emitter	-	20	V
V_{CES}	collector-emitter voltage	$R_{BE} = 0 \Omega$	-	15	V
V_{EBO}	emitter-base voltage		-	2.5	V
I _C	DC collector current	continuous	-	18	mA
P _{tot}	total power dissipation	up to $T_s = 135 ^{\circ}C$	[1] -	150	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	175	°C

^[1] T_s is the temperature at the soldering point of the collector tab.

6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{th(j-s)}$	from junction to soldering point		[1] 260	K/W

^[1] T_s is the temperature at the soldering point of the collector tab.

7. Characteristics

Table 7. Characteristics

 $T_j = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I_{CBO}	collector cut-off current	$I_E = 0 A; V_{CB} = 6 V$		-	-	50	nA
h _{FE}	DC current gain	$I_C = 5 \text{ mA}; V_{CE} = 6 \text{ V}$		60	120	250	
C _e	emitter capacitance	$I_C = I_c = 0 \text{ A}; V_{EB} = 0.5 \text{ V};$ f = 1 MHz		-	0.4	-	pF
C _c	collector capacitance	$I_E = i_e = 0 \text{ A}; V_{CB} = 6 \text{ V};$ f = 1 MHz		-	0.4	-	pF
C _{re}	feedback capacitance	$I_C = I_c = 0 \text{ A}; V_{CB} = 6 \text{ V};$ f = 1 MHz		-	0.3	-	pF
f _T	transition frequency	$I_C = 5 \text{ mA}; V_{CE} = 6 \text{ V};$ f = 1 GHz		-	9	-	GHz
G _{UM}	maximum unilateral power gain	$I_C = 5 \text{ mA}; V_{CE} = 6 \text{ V};$ $T_{amb} = 25 \text{ °C}; f = 900 \text{ MHz}$	[1]	-	17	-	dB
		$I_C = 5 \text{ mA}; V_{CE} = 6 \text{ V};$ $T_{amb} = 25 \text{ °C}; f = 2 \text{ GHz}$		-	10	-	dB
S ₂₁ ²	insertion power gain	$I_C = 5 \text{ mA}; V_{CE} = 6 \text{ V};$ $T_{amb} = 25 ^{\circ}\text{C}; f = 900 \text{ MHz}$		13	14	-	dB

NPN 9 GHz wideband transistor

Table 7. Characteristics ...continued $T_i = 25$ °C unless otherwise specified.

J	.)					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
F noise figure	noise figure	$\begin{split} &\Gamma_{\text{S}} = \Gamma_{\text{opt}}; \ I_{\text{C}} = 5 \ \text{mA}; \\ &V_{\text{CE}} = 6 \ \text{V}; T_{\text{amb}} = 25 \ ^{\circ}\text{C}; \\ &f = 900 \ \text{MHz} \end{split}$	-	1.2	1.7	dB
		$\begin{split} &\Gamma_{\text{S}} = \Gamma_{\text{opt}}; \ I_{\text{C}} = 5 \ \text{mA}; \\ &V_{\text{CE}} = 6 \ \text{V}; \\ &T_{\text{amb}} = 25 \ ^{\circ}\text{C}; \ \text{f} = 900 \ \text{MHz} \end{split}$	-	1.6	2.1	dB
		$\Gamma_{s} = \Gamma_{opt}$; $I_{C} = 5 \text{ mA}$; $V_{CE} = 6 \text{ V}$; $T_{amb} = 25 \text{ °C}$; $f = 2 \text{ GHz}$	-	1.9	-	dB
P _{L1}	output power at 1 dB gain compression	$\begin{split} &I_{C}=5\text{ mA; }V_{CE}=6\text{ V;}\\ &R_{L}=50\Omega;\\ &T_{amb}=25^{\circ}\text{C; }f=900\text{ MHz} \end{split}$	-	4	-	dBm
ITO	third order intercept point		[2] -	10	-	dBm

[1] G_{UM} is the maximum unilateral power gain, assuming S_{12} is zero and

$$G_{UM} = 10 \log \frac{\left|S_{2I}\right|^2}{(I - \left|S_{1I}\right|^2)(I - \left|S_{22}\right|^2)} dB$$

[2] I_C = 5 mA; V_{CE} = 6 V; R_L = 50 Ω ; T_{amb} = 25 °C; f_p = 900 MHz; f_q = 902 MHz; measured at $f_{(2p-q)}$ = 898 MHz and $f_{(2q-p)}$ = 904 MHz.

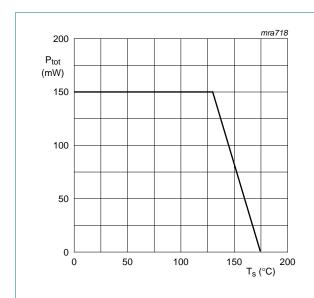
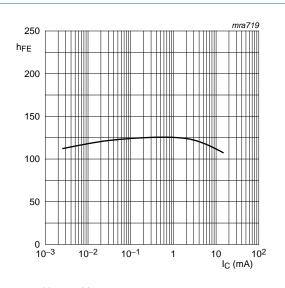


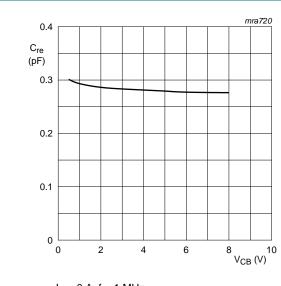
Fig 1. Power derating curve.



 $V_{CE} = 6 \text{ V}.$

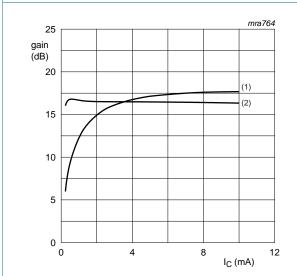
Fig 2. DC current gain as a function of collector current.

NPN 9 GHz wideband transistor



 $I_C = 0 A$; f = 1 MHz.

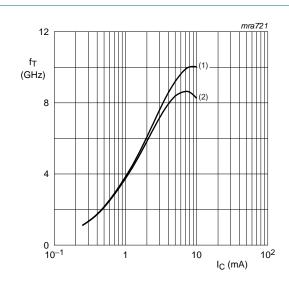
Fig 3. Feedback capacitance as a function of collector-base voltage.



 $V_{CE} = 6 \text{ V}; f = 900 \text{ MHz}.$

- (1) MSG.
- (2) G_{UM}.

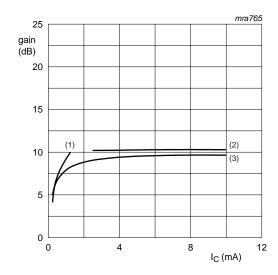
Fig 5. Gain as a function of collector current.



 $T_{amb} = 25 \,^{\circ}C$; $f = 1 \, GHz$.

- (1) $V_{CE} = 6 \text{ V}.$
- (2) $V_{CE} = 3 \text{ V}.$

Fig 4. Transition frequency as a function of collector current.



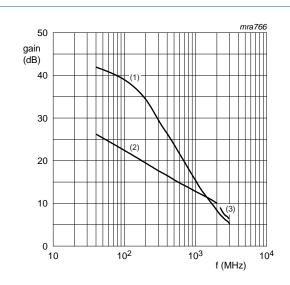
 $V_{CE} = 6 \text{ V}$; f = 2 GHz.

- (1) MSG.
- (2) G_{max}.
- (3) G_{UM}.

Fig 6. Gain as a function of collector current.

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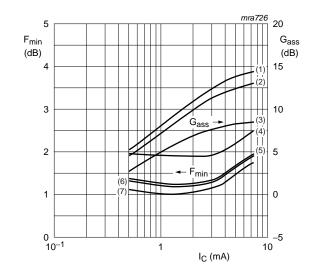
NPN 9 GHz wideband transistor



 $V_{CE} = 6 \text{ V}$; $I_{C} = 1.25 \text{ mA}$.

- (1) G_{UM}.
- (2) MSG.
- (3) G_{max}.

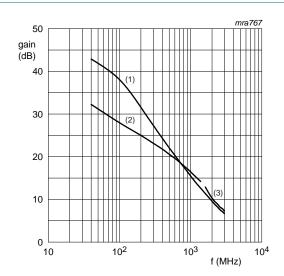
Fig 7. Gain as a function of frequency.



 $V_{CE} = 6 \text{ V}.$

- (1) f = 900 MHz.
- (2) f = 1000 MHz.
- (3) f = 2000 MHz.
- (4) f = 2000 MHz.
- (5) f = 1000 MHz.
- (6) f = 900 MHz.
- (7) f = 500 MHz.

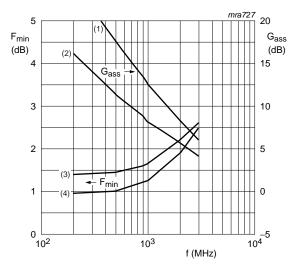
Fig 9. Minimum noise figure and associated available gain as functions of collector current.



 $V_{CE} = 6 \text{ V}; I_{C} = 5 \text{ mA}.$

- (1) G_{UM}.
- (2) MSG.
- (3) G_{max}.

Fig 8. Gain as a function of frequency.



 $V_{CE} = 6 \text{ V}.$

- (1) $I_C = 5 \text{ mA}.$
- (2) $I_C = 1.25 \text{ mA}.$
- (3) $I_C = 5 \text{ mA}.$
- (4) $I_C = 1.25 \text{ mA}.$

Fig 10. Minimum noise figure and associated available gain as functions of frequency.

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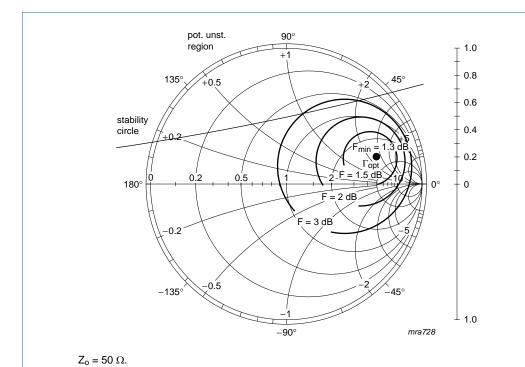
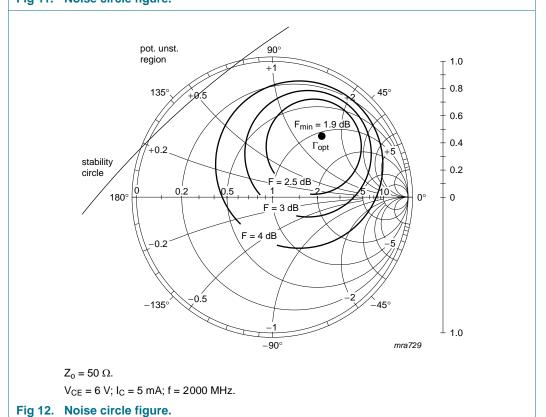


Fig 11. Noise circle figure.

 V_{CE} = 6 V; I_{C} = 5 mA; f = 900 MHz.



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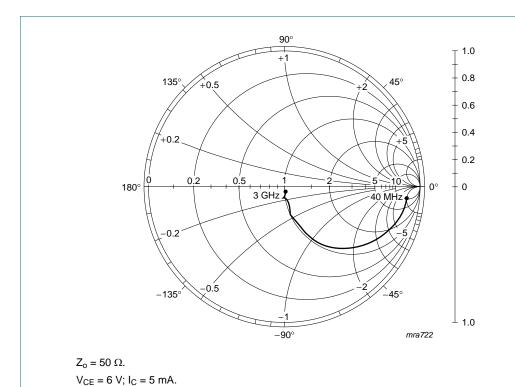


Fig 13. Common emitter input reflection coefficient (S₁₁).

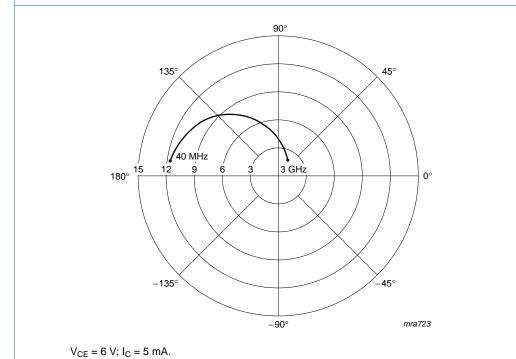


Fig 14. Common emitter forward transmission coefficient (S₂₁).

Product data sheet

8 of 14

NPN 9 GHz wideband transistor

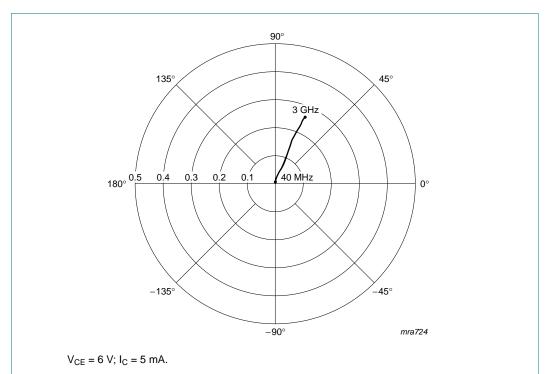
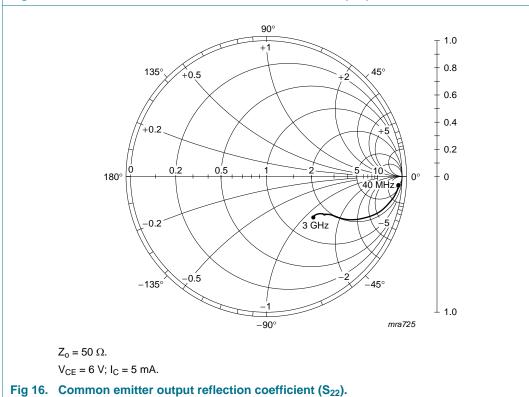


Fig 15. Common emitter reverse transmission coefficient (S₁₂).



NPN 9 GHz wideband transistor

8. Package outline

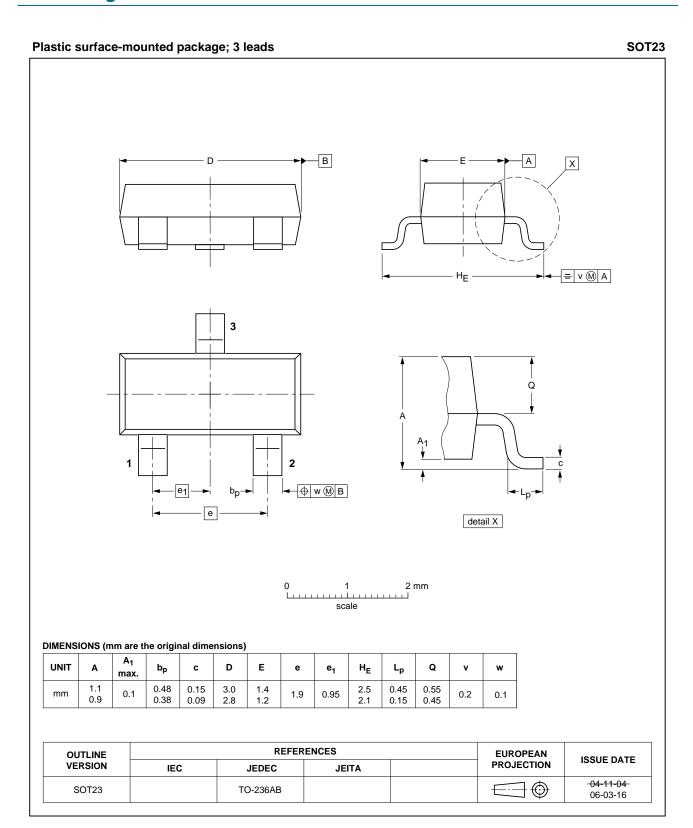


Fig 17. Package outline.

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9. Revision history

Table 8. Revision history

	•			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BFR505 v.4	20110907	Product data sheet	-	BFR505 v.3
Modifications: • The format of this data sheet has been guidelines of NXP Semiconductors.			redesigned to comply w	vith the new identity
	 Legal texts 	have been adapted to the ne	ew company name whe	ere appropriate.
	 Package ou 	ıtline drawings have been up	odated to the latest vers	sion.
BFR505 v.3 (9397 750 13396)	20040720	Product data sheet	-	BFR505_CNV v.2
BFR505_CNV v.2	19971204	Product specification	-	-

11 of 14

NPN 9 GHz wideband transistor

10. Legal information

10.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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NPN 9 GHz wideband transistor

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NPN 9 GHz wideband transistor

12. Contents

1	Product profile
1.1	General description 1
1.2	Features and benefits1
1.3	Quick reference data 1
2	Pinning information 2
3	Ordering information 2
4	Marking 2
5	Limiting values 3
6	Thermal characteristics 3
7	Characteristics 3
8	Package outline
9	Revision history 11
10	Legal information 12
10.1	Data sheet status
10.2	Definitions
10.3	Disclaimers
10.4	Trademarks13
11	Contact information
12	Contents 14

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